

Coded Note Number: **M5450**

Revision Level: **C002**

Date: **June 28, 2017**

Title: **HY AND HSLA STL PLATE PREP FOR TESTING**

This revision history is provided for convenience and does not alleviate the supplier's responsibility with understanding and complying with the full coded note.

Change from Revision C001– Editorial change to reformat to current standard.

Bolded font indicates changed/added content.

[*Text deleted*] inserted in the document indicates the removal of content.

Plate shall be cleaned to bare metal prior to inspection and shipment when not rolled to Thermal Mechanical Control Process (TMCP) requirements.